HIGH VOLTAGE SOLID STATE SWITCH

(INPUT: 27V – 42V, LOAD 1A)

(EF1005-0)



DATA SHEET Version 3.0 MARCH 2020



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PRODUCT DESCRIPTION

The device has four switches in a single ASIC. It can switch 1A load at 42V. This switch transistor is controlled through a control circuit. The control circuit operates from input voltage. When the control input is high (5V), the switch conducts and provides the load current (1A). Otherwise this switch remains off. The input voltage may be as low as 3.5V to be considered as High (>3.5V) which can turn on transistor.

FEATURES:

- Raw bus voltage: 27 V to 42 V
- Full load current: 1 A
- Control voltage: 3.5 V to 5.5 V
- Output drop (V_{SD}) : 650 mV at 1 A
- Input (leakage) current: 0.19mA
- Quiescent current (I_{GND}): 40nA
- AMS's 0.35µm high voltage process H35B4D3
- ASIC functionally equivalent to HMC 112SS

DEVICE SUMMARY:

Table 1: Device Summary						
DEVICE	*DIE SIZE	PACKAGE	PINS	DESCRIPTIO N	TEMPERATURE RANGE	
EF1005-0	6.75mm X 6.94mm Ceramic Package	Chip on Board (COB)	32 pins	Evaluation Model	-55°C to +125°C	
		Ceramic Flat Package (CFP)	48 Lead	Engineering Model		

POWER ON SEQUENCE:

- 1. RAW BUS VOLTAGE (RB)
- 2. CONTROL INPUT VOLTAGE (IN)



BLOCK DIAGRAM:



Figure 1: Block Diagram

PIN CONFIGURATION:



Figure 2: Pin Diagram of COB package





Figure 3: Pin Diagram of CFP package

PIN DESCRIPTION (COB Package):

Pin description for the leadless COB is given in the below table. Control input = $0V \Rightarrow Switch off$, Control input = $5V \Rightarrow Switch on$.

Table 2: Pin	description	for	COB
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PIN NO.	PIN NAME	DESCRIPTION
1	MON1	Monitor voltage for switch - 1
2	NC	
3	DG12	Common ground for switch- 1 and 2
4	OUT1	Output pin for switch - 1
5	OUT1_1	Output pin for switch - 1
6	OUT2	Output pin for switch - 2
7	OUT2_1	Output pin for switch - 2
8	MON2	Monitor voltage for switch - 2
9	IN2	Control input for switch - 2
10	RET2	Return for switch - 2
11	RB2	Raw bus voltage (27V- 42V) for switch - 2
12	RB2_1	Raw bus voltage (27V- 42V) for switch - 2
13	RB3	Raw bus voltage (27V- 42V) for switch - 3



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PIN NO.	PIN NAME	DESCRIPTION
14	RB3_1	Raw bus voltage (27V- 42V) for switch - 3
15	RET3	Return for switch - 3
16	IN3	Control input for switch - 3
17	MON3	Monitor voltage for switch - 3
18	NC	
19	OUT3	Output pin for switch - 3
20	OUT3_1	Output pin for switch - 3
21	OUT4	Output pin for switch - 4
22	OUT4_1	Output pin for switch - 4
23	DG34	Common l ground for switch - 3 and 4
24	MON4	Monitor voltage for switch - 4
25	IN4	Control input for switch - 4
26	RET4	Return signal for switch - 4
27	RB4_1	Raw bus voltage (27V- 42V) for switch - 4
28	RB4	Raw bus voltage (27V- 42V) for switch - 4
29	RB1_1	Raw bus voltage (27V- 42V) for switch - 1
30	RB1	Raw bus voltage (27V- 42V) for switch - 1
31	RET1	Return for switch - 1
32	IN1	Control input for switch - 1

PIN DESCRIPTION (Ceramic Flat Package):

Pin description for the 48 pin CFP is given in the below table.

PIN NO.	PIN NAME	DESCRIPTION
1		NC
2	RB1_1	Raw bus voltage (27V- 42V) for switch - 1
3	RB1	Raw bus voltage (27V- 42V) for switch - 1
4	RET1	Return for switch - 1
5	IN1	Control input for switch - 1

Table 3: Pin description for package



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PIN NO.	PIN NAME	DESCRIPTION
6		NC
7		NC
8		NC
9	MON1	Monitor voltage for switch - 1
10	DG12	Common ground for switch - 1 and 2
11	OUT1	Output pin for switch - 1
12	OUT1_1	Output pin for switch - 1
13	OUT2	Output pin for switch - 2
14	OUT2_1	Output pin for switch - 2
15	MON2	Monitor voltage for switch - 2
16		NC
17		NC
18		NC
19		NC
20	IN2	Control input for switch – 2
21	RET2	Return for switch - 2
22	RB2	Raw bus voltage (27V- 42V) for switch - 2
23	RB2_1	Raw bus voltage (27V- 42V) for switch - 2
24		NC
25		NC
26	RB3	Raw bus voltage (27V- 42V) for switch - 3
27	RB3_1	Raw bus voltage (27V- 42V) for switch - 3
28	RET3	Return for switch - 3
29	IN3	Control input for switch - 3
30		NC
31		NC
32		NC
33		NC
34	MON3	Monitor voltage for switch - 3
35	OUT3	Output pin for switch - 3
36	OUT3_1	Output pin for switch - 3
37	OUT4	Output pin for switch - 4



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PIN NO.	PIN NAME	DESCRIPTION
38	OUT4_1	Output pin for switch - 4
39	DG34	Common ground for switch - 3 and 4
40	MON4	Monitor voltage for switch - 4
41		NC
42		NC
43		NC
44	IN4	Control input for switch - 4
45	RET4	Return signal for switch - 4
46	RB4_1	Raw bus voltage (27V- 42V) for switch - 4
47	RB4	Raw bus voltage (27V- 42V) for switch - 4
48		NC

ABSOLUTE MAXIMUM RATING ⁽¹⁾: Over operating free-air temperature range (unless otherwise stated).

Table 4. Absolu	te maximum ra	ung	
PARAMETER	MIN.	MAX.	UNIT
VGS	-	5.5	V
VSD	-	120	V
Ambient Temperature Range	-55	125	°C

Table 4: Absolute maximum rating

⁽¹⁾Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITIONS:

Table 5: Recommended Operating Condition

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNIT
RB	Raw Bus	27	37	42	V
I _{LOAD}	Output drive current	0	-	1	А
T _A	Ambient temperature range	-55	-	+125	°C



ELECTRICAL SPECIFICATIONS

Test condition: All these tests are conducted at RB = 42V, Load = 1A, -55°C \leq T_A \leq 125°C, No C_{IN} and C_{OUT} are used in testing, unless otherwise specified. The 4 – Wire measurement method has been employed in the test setup.

PARAMETER	TEST CONDITIONS	MIN.	ТҮР.	MAX.	UNITS
Supply RB	$V_I = 5V$	27	-	42	V
Control Voltage – V _I	Load=1A	3.5	5	5.5	V
Input Current –I _{IH}	$V_I = 5V$	-	0.186	0.5	mA
Output drop – V _{SD}	$V_I = 5V$	0.35	0.62	0.85	V
Output current –I _O	Load = No load, $V_I = 5V$	-	0.14	0.8	mA
Output Voltage –V _{OUT}	$V_I = 5V$	41.15	41.38	41.65	V
Monitor Voltage-V _{MON}	$V_I = 5V$	6.7	7.07	7.8	V
Quiescent Current	Load= No load, $V_I = 0V$	-	0.003	20	μΑ
Switch Delay On*	Load = 1mA	2.0	2.96	5.0	μs
Switch Delay Off*	Load = 1mA	0.4	0.63	0.85	ms

 Table 6: Electrical specifications in Temperature Range

Note: * marked parameters are tested on sample basis at lab temperature $(T_A) = 23^{\circ}C \pm 2^{\circ}C$



TYPICAL CHARACTERISTICS

All these tests are conducted: RB = 42V, $V_I = 5V$, $-55^{\circ}C \le T_A \le 125^{\circ}C$, No C_{IN} and C_{OUT} are used in testing, unless otherwise specified. The 4–Wire Kelvin Bridge method has been employed to carry out these tests.



All these tests are conducted: RB = 42V, $V_I = 5V$, Load = 0.1A, -55°C $\leq T_A \leq 125$ °C, No C_{IN} and C_{OUT} are used in testing, unless otherwise specified.







All these tests are conducted: RB = 42V, $V_I = 5V$, Load = 1A, -55°C $\leq T_A \leq 125$ °C, No C_{IN} and C_{OUT} are used in testing, unless otherwise specified.





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KEY TERMS:

- **1.** Control Voltage (V_I): The voltage applied to turn on/off the circuit. It is applied at the switch control circuit connected to the PMOS gate.
- 2. Input Current (I_I): The leakage current of the control circuit.
- 3. Supply Voltage (RB): The raw bus voltage which acts as supply to the PMOS switch.
- 4. Output Voltage (V_{OUT}): The voltage obtained at the output terminal when the switch is on.
- 5. Output drop (V_{SD}): The voltage drop across the PMOS due to its effective resistance R_{ON} .

$$V_{SD} = RB - V_{OUT}$$

6. Monitoring Voltage (V_{MON}): It is the output voltage across a register divider network to provide 5-9 V voltage for monitoring the operation of switch.



- 7. Output current (I_O): The open circuit current passing through resistor divider network when no load is applied.
- 8. Quiescent Current: Total bias current (different from load current) consumed by different blocks of the device for their operation.
- 9. \mathbf{R}_{ON} : \mathbf{R}_{ON} is the total resistance between the drain and source in a MOSFET when it is on which accounts for voltage drop V_{SD} .
- **10. Output Noise:** Unwanted disturbance in the electrical signal at the output terminal of the device.



PACKAGE DRAWING (CFP PACKAGE)



CHIP ON BOARD LAYOUT CONSIDERATIONS



Figure 4: COB Evaluation Package

Remarks: COB Pin 2 and Pin 18 are NC (NO COB tracks are connected)

REVISION HISTORY

Doc. name	Release Date	Data sheet status	Version
Product Data Sheet	July - 2019	Development	Ver1.0
Product Data Sheet	Sept - 2019	Development	Ver2.0
Product Data Sheet	March - 2020	Development	Ver3.0

Table 7: Revision History

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